ISO 9001 Registered

IMP5218

9-Line SCSI Terminator
Plug and Play

DESCRIPTION

The IMP5218 terminator is part of IMP's SCSI terminator family of high-performance, adaptive, non-linear mode SCSI products, which are designed to deliver true UltraSCSI performance in SCSI applications. The low voltage BiCMOS architecture employed in its design offers performance superior to older linear passive and active techniques. IMP's SCSI terminator architecture employs high-speed adaptive elements for each channel, thereby providing the fastest response possible — typically 35MHz, which is 100 times faster than the older linear regulator/terminator approach used by other manufacturers. Products using this older linear regulator approach have bandwidths which are dominated by the output capacitor and which are limited to 500KHz (see further discussion in the Functional Description section). This new architecture also eliminates the output compensation capacitor required in earlier terminator designs. Each is approved for use with SCSI-1, -2, -3, UltraSCSI and beyond — providing the highest performance alternative available today.

Another key improvement offered by the IMP5218 lies in its ability to insure reliable, error free communications even in systems which do not adhere to recommended SCSI hardware design guidelines, such as the use of improper cable lengths and impedances. Frequently, this situation is not controlled by the peripheral or host designer and, when problems occur, they are the first to be made aware of the problem. The IMP5218 architecture is much more tolerant of marginal system integrations.

The IMP5218 has two disconnect pins for SCSI Plug and Play (PnP) applications. Quiescent current is typically less than 275µA in this mode, while the output capacitance is also less than 3pF. The obvious advantage of extended battery life for portable systems is inherent in the product's disable-mode feature. Additionally, the disable function permits factory-floor or production-line configurability, reducing inventory and product-line diversity costs. Field configurability can also be accomplished without physically removing components which, often times results in field returns due to mishandling.

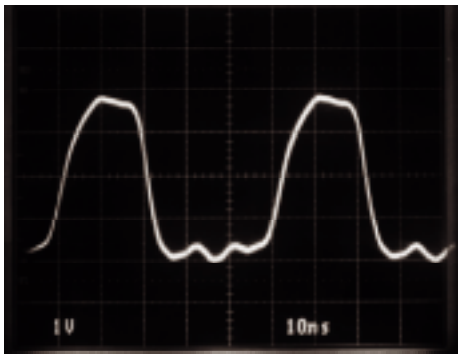
Reduced component count is also inherent in the IMP5218 architecture. Traditional termination techniques require large stabilization and transient protection capacitors of up to 20µF in value and size. The IMP5218 architecture does not require these components, allowing all the cost savings associated with reduced inventory, board space, and assembly, plus higher reliability.

KEY FEATURES

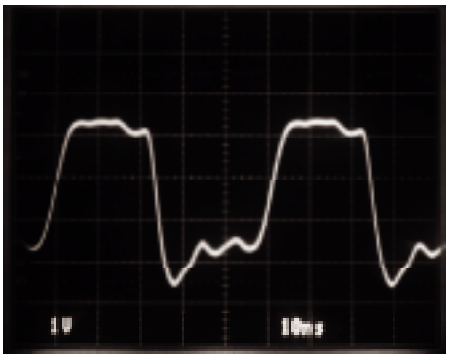
- SCSI PLUG AND PLAY, DUAL LOW DISCONNECT, LOGIC LOW COMMAND DISCONNECTS ALL TERMINATION LINES
- HOT SWAP COMPATIBLE
- ULTRA-FAST RESPONSE FOR FAST-20 SCSI APPLICATIONS
- 35MHz CHANNEL BANDWIDTH
- 3.5V OPERATION
- LESS THAN 3pF OUTPUT CAPACITANCE
- DISABLE-MODE CURRENT LESS THAN 275µA
- THERMALLY SELF LIMITING
- NO EXTERNAL COMPENSATION CAPACITORS
- IMPLEMENTS 8-BIT OR 16-BIT (*WIDE*) APPLICATIONS
- COMPATIBLE WITH ACTIVE NEGATION DRIVERS (60mA / CHANNEL)
- COMPATIBLE WITH PASSIVE AND ACTIVE TERMINATIONS
- APPROVED FOR USE WITH SCSI 1, 2, 3 AND ULTRASCSI

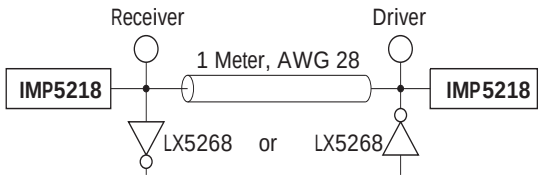
PRODUCT HIGHLIGHT

RECEIVING WAVEFORM - 20MHZ



DRIVING WAVEFORM - 20MHZ





PACKAGE ORDER INFORMATION

T_J (°C)	DW Plastic SOWB 16-pin	PW Plastic TSSOP 20-pin
0 to 125	IMP5218CDW	IMP5218CPW

Note: All surface-mount packages are available in Tape & Reel.
Append the letter "T" to part number. (i.e. IMP5218CDWT)

ABSOLUTE MAXIMUM RATINGS (Note 1)

Continuous Termination Voltage 10V
Continuous Output Voltage Range ..... 0 to 5.5V
Continuous Disable Voltage Range ..... 0 to 5.5V
Operating Junction Temperature ..... 0°C to 125°C
Storage Temperature Range ..... -65°C to +150°C
Solder Temperature (Soldering, 10 seconds) ..... 300°C

Note 1. Exceeding these ratings could cause damage to the device.

THERMAL DATA

DW PACKAGE:

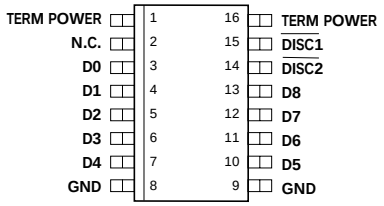
THERMAL RESISTANCE-JUNCTION TO AMBIENT, Q_{JA} ..... 95°C/W

PW PACKAGE:

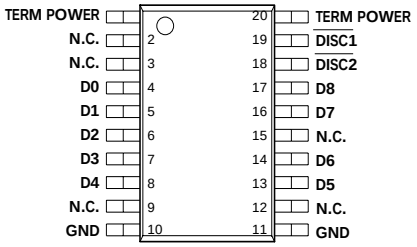
THERMAL RESISTANCE-JUNCTION TO AMBIENT, Q_{JA} ..... 144°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.
The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system.
All of the above assume no ambient airflow.

PACKAGE PIN OUTS



DW PACKAGE
(Top View)



PW PACKAGE
(Top View)

RECOMMENDED OPERATING CONDITIONS (Note 2)

Parameter	Symbol	Recommended Operating Conditions			Units
		Min.	Typ.	Max.	
Termination Voltage	V_{TERM}	3.5		5.5	V
High Level Disable Input Voltage	V_{IH}	2		V_{TERM}	V
Low Level Disable Input Voltage	V_{IL}	0		0.8	V
Operating Virtual Junction Temperature Range		0		125	°C

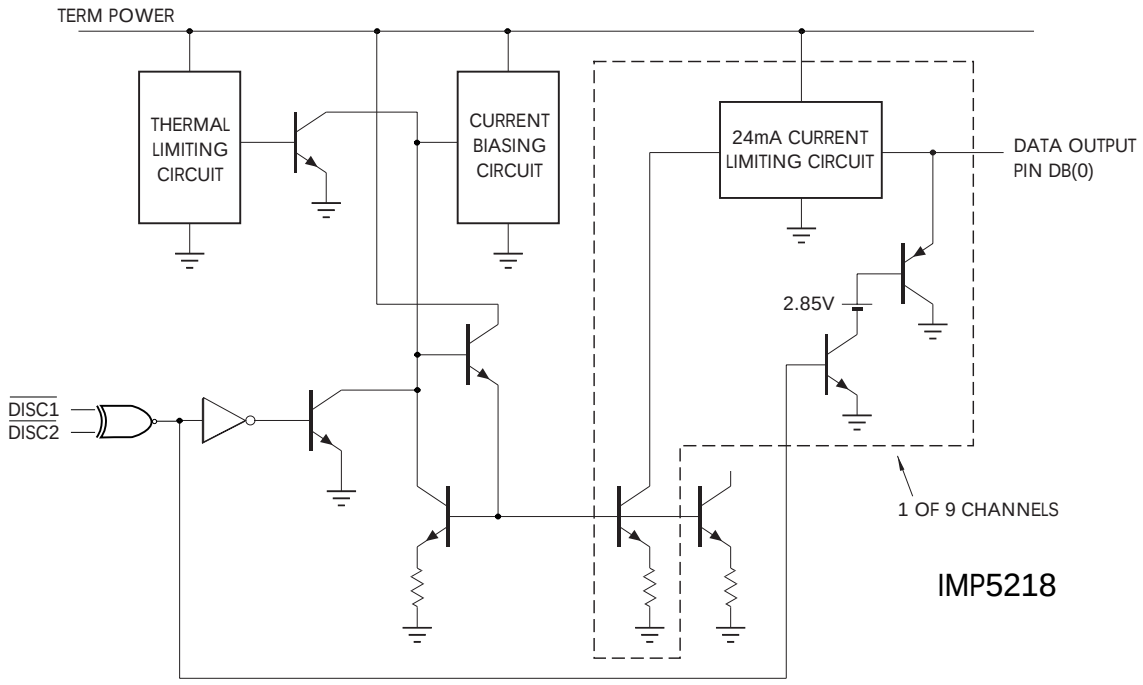
Note 2. Range over which the device is functional.

ELECTRICAL CHARACTERISTICS

Term Power = 4.75V unless otherwise specified. Unless otherwise specified, these specifications apply at the recommended operating ambient temperature of T_A = 25°C. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.

Parameter	Symbol	Test Conditions	IMP5218			Units
			Min.	Typ.	Max.	
Output High Voltage	V_{OUT}		2.65	2.85		V
TermPwr Supply Current	I_{CC}	All data lines = open		6	9	mA
		All data lines = 0.5V		215	225	mA
		$\overline{DISC1}$ = $\overline{DISC2}$ = 0V		275		µA
Output Current	I_{OUT}	V_{OUT} = 0.5V	-21	-23	-24	mA
Disable Input Current	I_{IN}	$\overline{DISC1}$ = $\overline{DISC2}$ = 4.75V		90		µA
		$\overline{DISC1}$ = $\overline{DISC2}$ = 0V		-10		nA
Output Leakage Current		$\overline{DISC1}$ = $\overline{DISC2}$ = 0V, V_O = 0.5V		10		nA
Capacitance in Disabled Mode	C_{OUT}	V_{OUT} = 0V, frequency = 1MHz		3		pF
Channel Bandwidth	BW			35		MHz
Termination Sink Current, per Channel	I_{SINK}	V_{OUT} = 4V		60		mA

BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION

Cable transmission theory suggests to optimize signal speed and quality, the termination should act both as an ideal voltage reference when the line is released (deasserted) and as an ideal current source when the line is active (asserted). Common active terminators, which consist of Linear Regulators in series with resistors (typically 110Ω), are a compromise. As the line voltage increases, the amount of current decreases linearly by the equation V = I ∗ R. The IMP5218, with its unique new architecture applies the maximum amount of current regardless of line voltage until the termination high threshold (2.85V) is reached.

Acting as a near ideal line terminator, the IMP5218 closely reproduces the optimum case when the device is enabled. To enable the device the $\overline{\text{DISC1}}$ and $\overline{\text{DISC2}}$ Pins must be pulled logic High, Open, or any combination of both High and Low. During this mode of operation, quiescent current is 6mA and the device will respond to line demands by delivering 24mA on assertion and by imposing 2.85V on deassertion. In order to disable the device, the $\overline{\text{DISC1}}$ and $\overline{\text{DISC2}}$ pins must be driven logic Low. This mode of operation places the device in a sleep state where a meager 275µA of quiescent current is consumed. Additionally, all outputs are in a Hi-Z (impedance) state. Sleep mode can be used for power conservation or to completely eliminate the terminator from the SCSI chain. In the second case, termination node capacitance is important to consider. The terminator will appear as a parasitic distributed capacitance on the line, which can detract from bus performance. For this reason, the IMP5218 has been optimized to have only 3pF of capacitance per output in the sleep state.

POWER UP / POWER DOWN FUNCTION TABLE

$\overline{\text{DISC1}}$	$\overline{\text{DISC2}}$	Outputs	Quiescent Current
H	H	Enabled	6mA
H	L	Enabled	6mA
L	H	Enabled	6mA
L	L	Disabled	275µA
Open	Open	Enabled	6mA

An additional feature of the IMP5218 is its compatibility with active negation drivers. The device handles up to 60mA of sink current for drivers which exceed the 2.85V output High.

GRAPH / CURVE INDEX

Waveforms

FIGURE #

Characteristic Curves

FIGURE #

FIGURE INDEX

Application Circuits

FIGURE #

CHARACTERISTIC CURVES

FIGURE 1A. — RECEIVING WAVEFORM

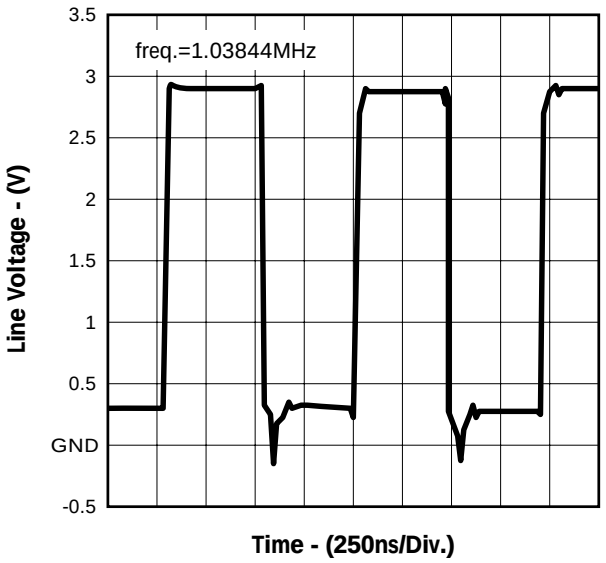
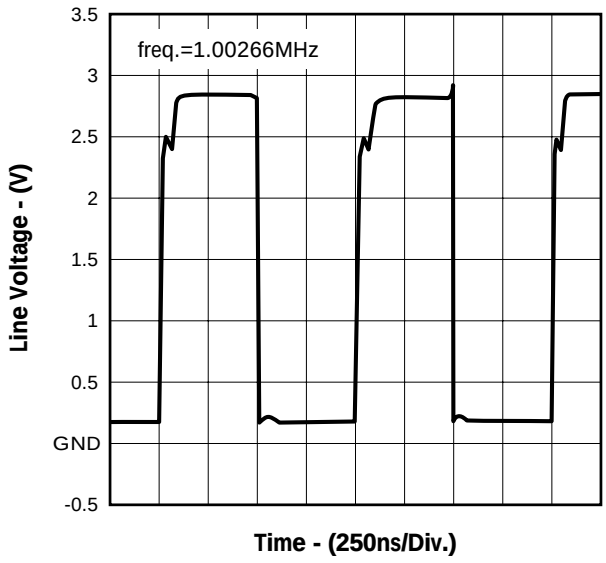
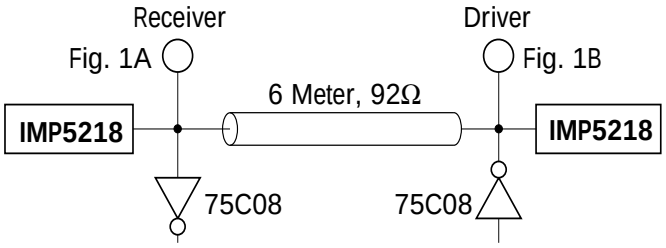


FIGURE 1B. — DRIVING WAVEFORM



END-DRIVEN CABLE



CHARACTERISTIC CURVES

FIGURE 2A. — RECEIVING WAVEFORM

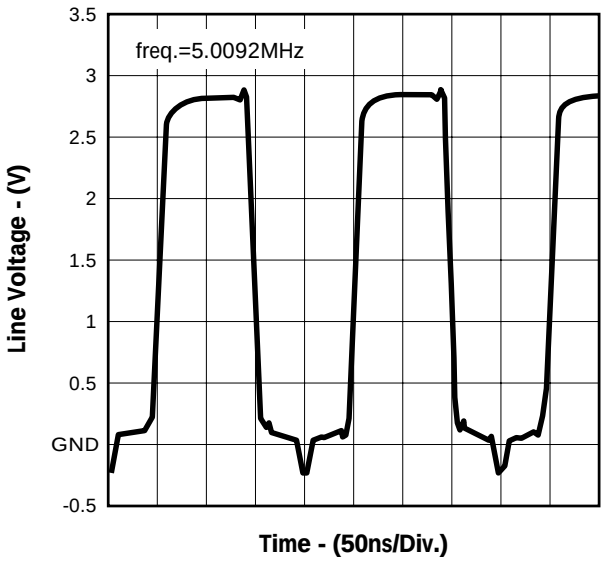
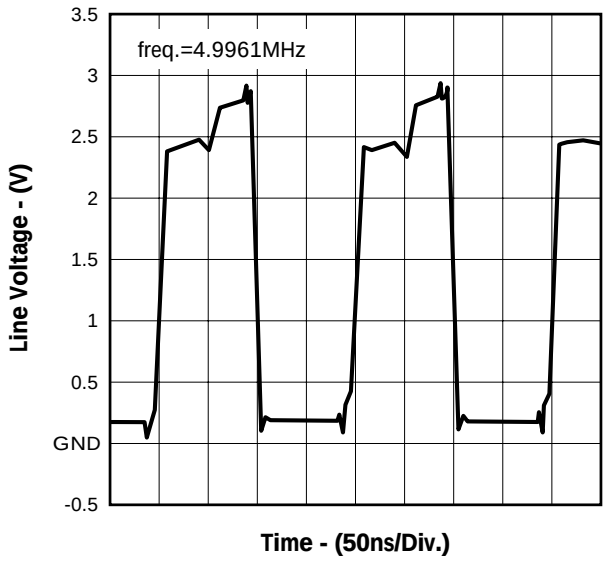


FIGURE 2B. — DRIVING WAVEFORM



END-DRIVEN CABLE

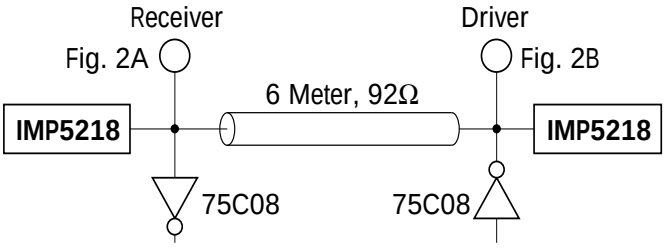


FIGURE 3. — 10MHz WAVEFORM

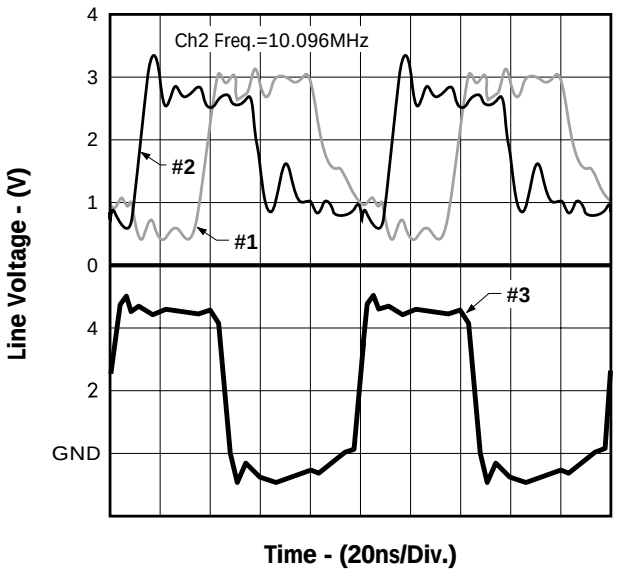
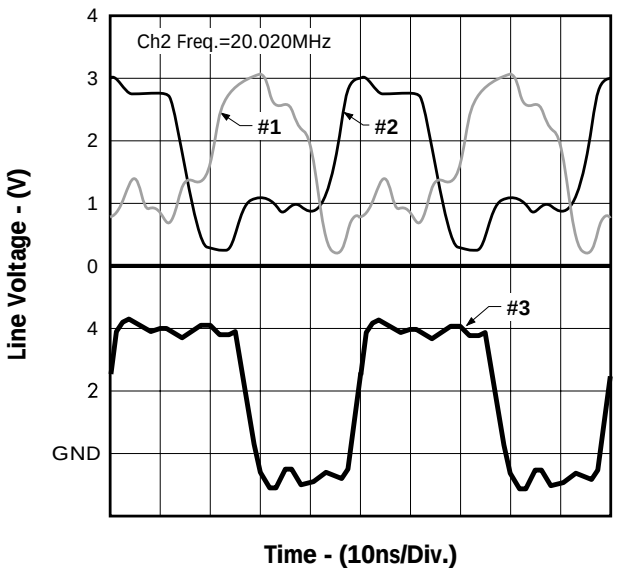


FIGURE 4. — 20MHz WAVEFORM



END-DRIVEN CABLE

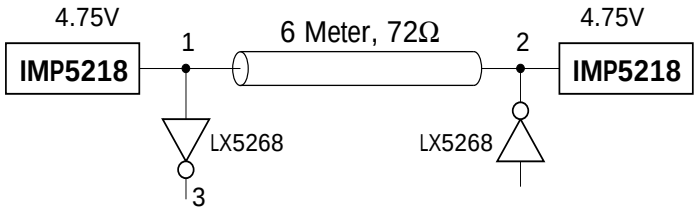


FIGURE 5. — OUTPUT HIGH VOLTAGE vs. JUNCTION TEMP.

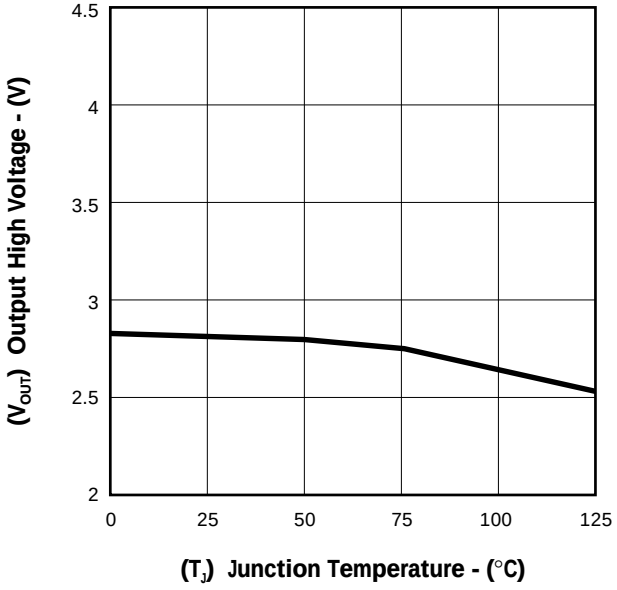


FIGURE 6. — OUTPUT CURRENT vs. JUNCTION TEMP.

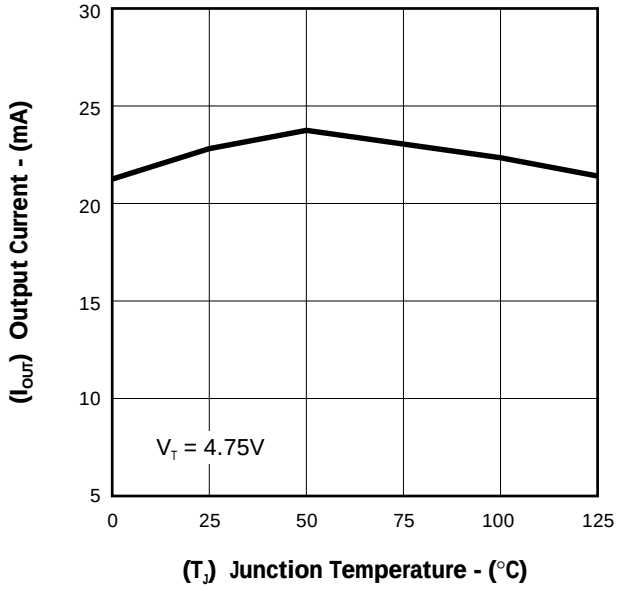


FIGURE 7. — OUTPUT CURRENT vs. OUTPUT HIGH VOLTAGE

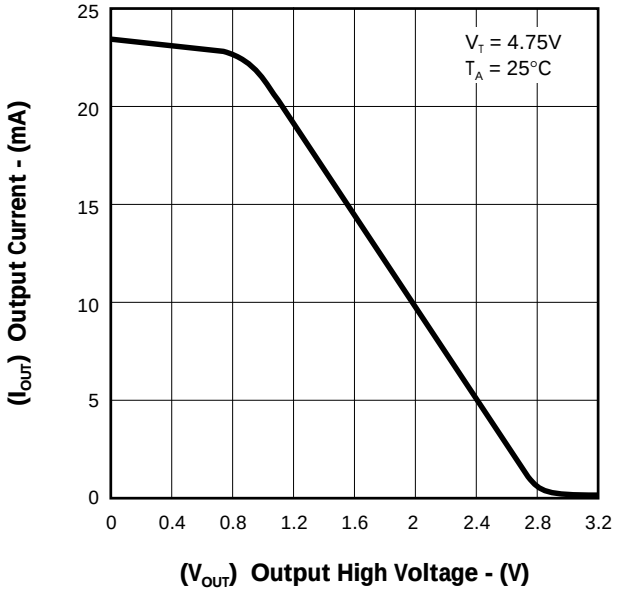


FIGURE 8. — OUTPUT CURRENT vs. OUTPUT HIGH VOLTAGE

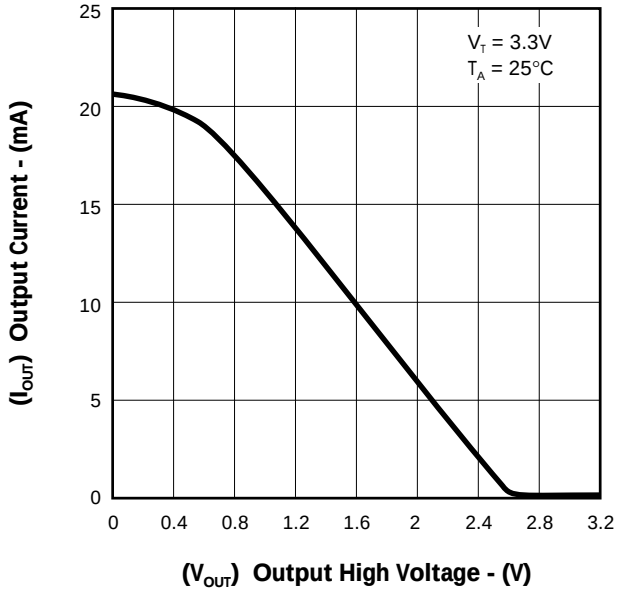


FIGURE 9. — TERMPWR SUPPLY CURRENT vs. TERMINATION VOLTAGE

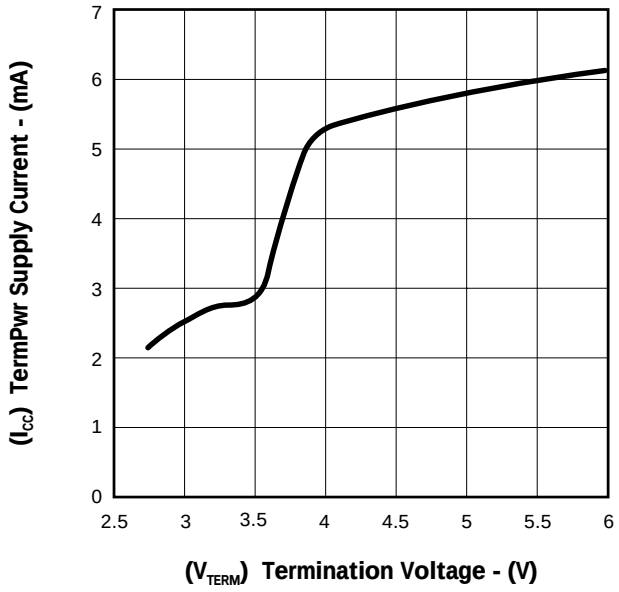


FIGURE 10. — TERMPWR SUPPLY CURRENT vs. TERMINATION VOLTAGE (Disabled)

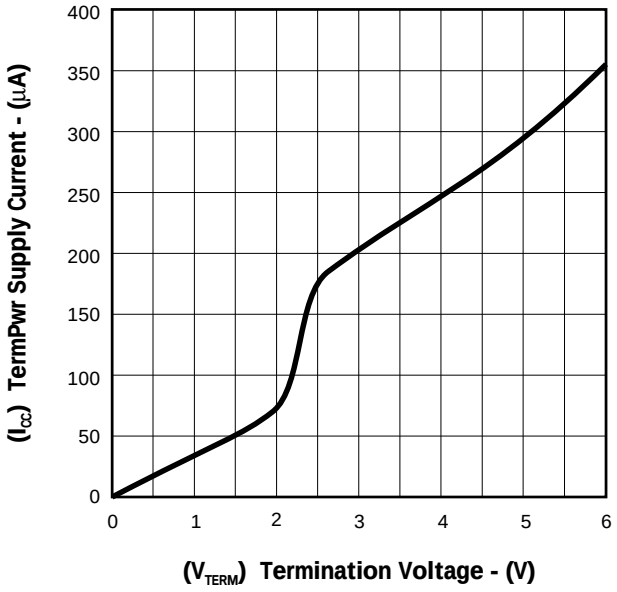


FIGURE 11. — OUTPUT HIGH VOLTAGE vs. JUNCTION TEMP.

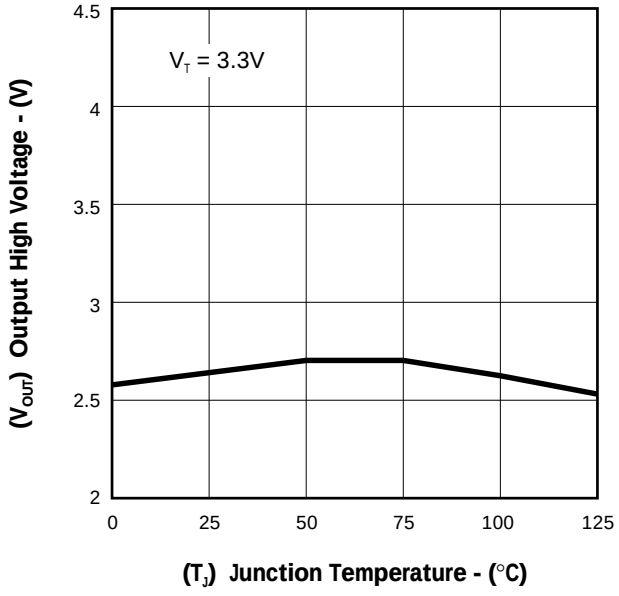


FIGURE 12. — OUTPUT CURRENT vs. JUNCTION TEMP.

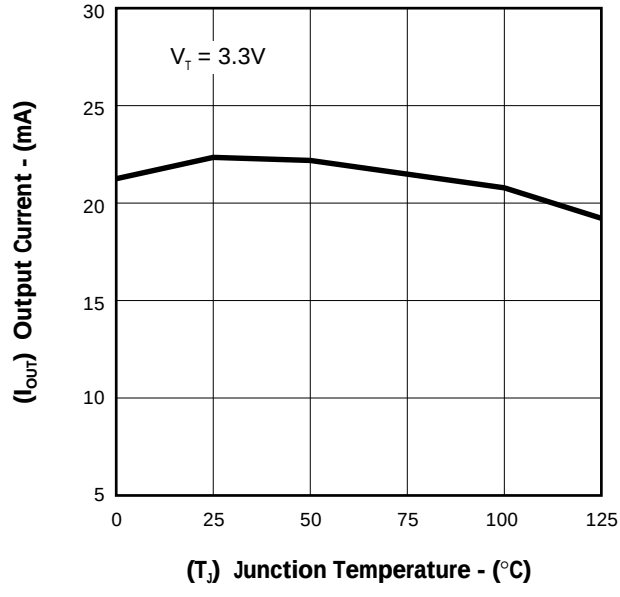


FIGURE 13. — OUTPUT HIGH VOLTAGE vs. TERMINATION VOLTAGE

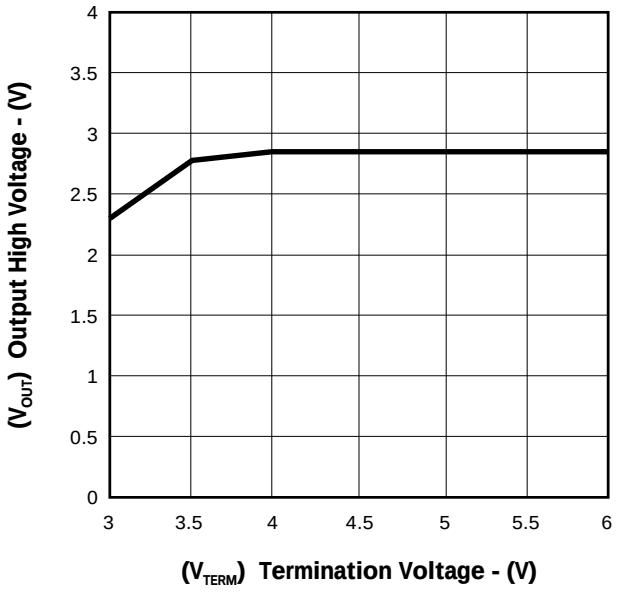
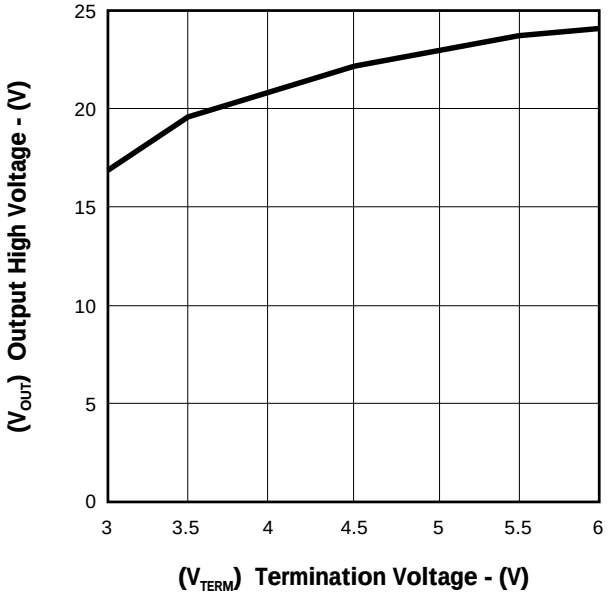
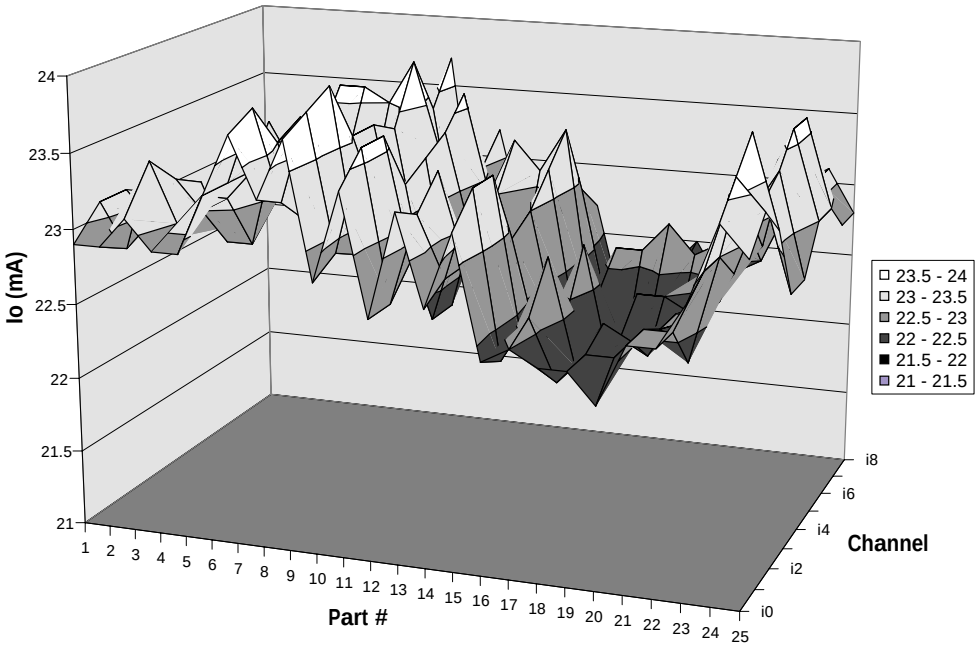


FIGURE 14. — OUTPUT CURRENT vs. TERMINATION VOLTAGE



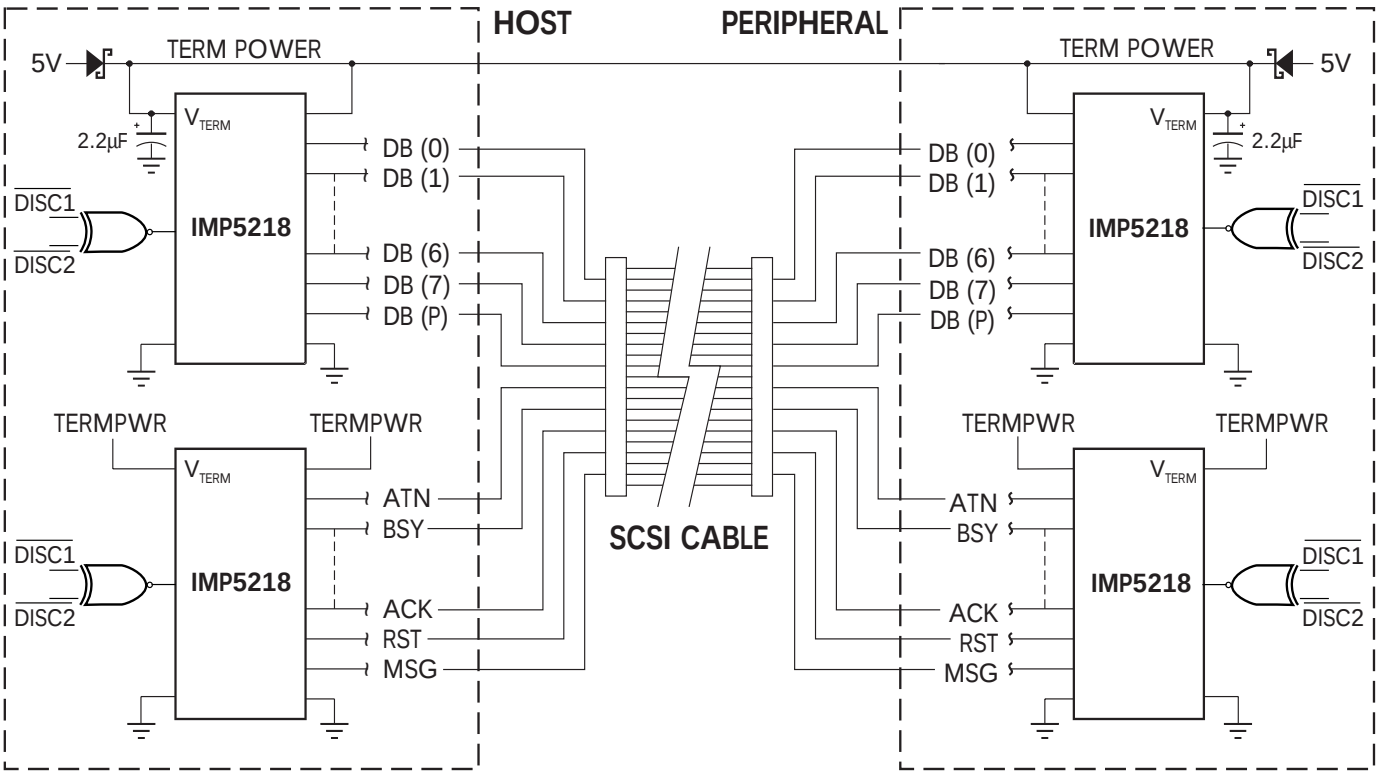
CHARACTERISTIC CURVES

FIGURE 16. — OUTPUT CURRENT CHANNEL TO CHANNEL MATCHING



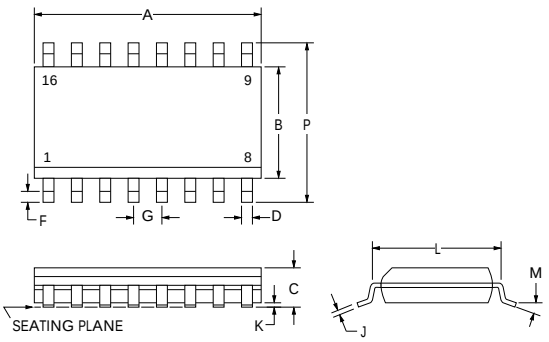
APPLICATION SCHEMATIC

FIGURE 17 — 8-BIT SCSI SYSTEM APPLICATION



Note: Add third IMP5218 for 16-bit SCSI

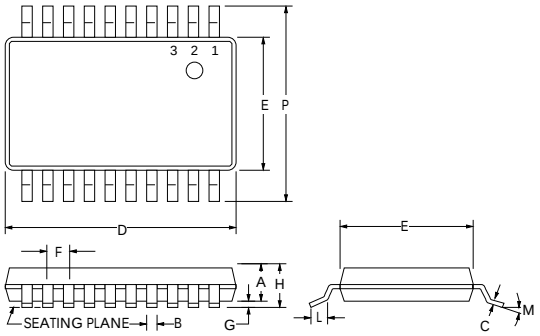
DW 16-Pin Plastic (SOWB) Widebody S.O.I.C.



	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	—	10.67	—	0.420
B	7.49	7.75	0.295	0.305
C	2.35	2.65	0.093	0.104
D	0.25	0.46	0.010	0.018
F	0.64	0.89	0.025	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.10	0.30	0.004	0.012
L	8.13	8.64	0.320	0.340
M	0°	8°	0°	8°
P	10.26	10.65	0.404	0.419

*** See NOTE: 1**

PWP 20-Pin Thin Small Shrink Outline (TSSOP)



	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	—	0.90	—	0.354
B	0.18	0.30	0.0071	0.0118
C	0.90	0.180	0.0035	0.0071
D	6.40	6.60	0.252	0.260
E	4.30	4.48	0.169	0.176
F	0.65 BSC		0.025 BSC	
G	0.05	0.15	0.002	0.005
H	—	1.10	—	0.0433
L	0.50	0.70	0.020	0.028
M	0°	8°	0°	8°
P	6.25	6.50	0.246	0.256

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